RoHS COMPLIANT

HALOGEN

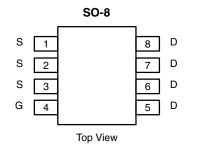
FREE



Vishay Siliconix

N-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω) (Max.)	I _D (A) ^a	Q _g (Typ.)			
30	0.0034 at V _{GS} = 10 V	31.3	22.5 nC			
	0.0044 at V_{GS} = 4.5 V	27.5	22.3110			



Ordering Information:

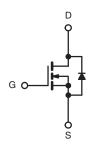
Si4010DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- TrenchFET[®] Power MOSFET
- 100 % R_g and UIS Tested
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Synchronous Rectification
- DC/DC Conversion
- Telecom/Server
- Industrial



N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	S (T _A = 25 °C, u	Inless otherw	vise noted)		
Parameter		Symbol Limit		Unit	
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	+ 20, - 16	v	
	T _C = 25 °C		31.3		
Continuous Drain Current (T. 150 °C)	T _C = 70 °C	1 , [24.9		
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	T _A = 25 °C	I _D	20.2 ^{b, c}		
	T _A = 70 °C	1 [16.1 ^{b, c}		
Pulsed Drain Current (t = 300 µs)		I _{DM}	100	— A	
Continuous Source-Drain Diode Current	T _C = 25 °C		5.4		
	T _A = 25 °C	I _S	2.2 ^{b, c}		
Single Pulse Avalanche Current	L = 0.1 mH		20		
Single Pulse Avalanche Energy			20	mJ	
	T _C = 25 °C		6		
Mariana Davida Diadia ati an	T _C = 70 °C		3.8		
Maximum Power Dissipation	T _A = 25 °C	P _D	2.5 ^{b, c}	W	
	T _A = 70 °C	1 [1.6 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS								
Parameter		Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	37	50	°C/W			
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	17	21	0/10			

Notes

- a. Based on $T_C = 25$ °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under steady state conditions is 85 °C/W.

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Si4010DY

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static					•		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	1 250.04		14		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	l _D = 250 μA		- 5.5			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1		2.3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = + 20 V, - 16 V$			± 100	nA	
	I _{DSS}	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μA	
Zero Gate Voltage Drain Current		V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	40			Α	
		V _{GS} = 10 V, I _D = 15 A		0.0028	0.0034		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		0.0035	0.0044	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		105		S	
Dynamic ^b					•		
Input Capacitance	C _{iss}			3595		pF	
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		1040			
Reverse Transfer Capacitance	C _{rss}			79			
	0	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		51	77		
Total Gate Charge	Qg			22.5	34	nC	
Gate-Source Charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		8.6			
Gate-Drain Charge	Q _{gd}			4			
Output Charge	Q _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}$		30.5			
Gate Resistance	Rg	f = 1 MHz	0.5	1.25	2	Ω	
Turn-On Delay Time	t _{d(on)}			24	48		
Rise Time	t _r	$V_{DD} = 15 \text{ V}, \text{ R}_{1} = 1.5 \Omega$		17	34		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ Å}, V_{\text{GEN}} = 4.5 \text{ V}, \text{R}_{\text{g}} = 1 \Omega$		25	50		
Fall Time	t _f			12	24		
Turn-On Delay Time	t _{d(on)}			12	24	ns	
Rise Time	t _r	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{I}} = 1.5 \Omega$		10	20	-	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10$ Å, $V_{GEN} = 1.5$ V, $R_g = 1$ Ω		30	60		
Fall Time	t _f			9	18		
Drain-Source Body Diode Characterist	cs						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			5.4	•	
Pulse Diode Forward Current	I _{SM}				100	A	
Body Diode Voltage	V _{SD}	I _S = 5 A,		0.73	1.1	V	
Body Diode Reverse Recovery Time	t _{rr}			36	70	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			24	48	nC	
Reverse Recovery Fall Time	t _a	I _F = 10 A, dl/dt = 100 A/μs, T _J = 25 °C		16	1		
Reverse Recovery Rise Time	t _b			20	1	ns	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

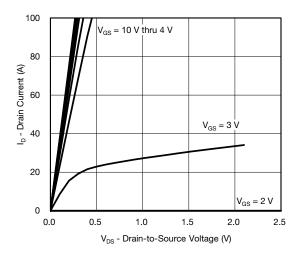
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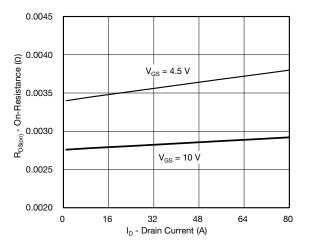


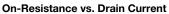
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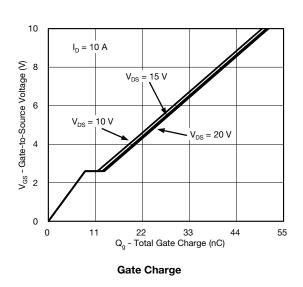
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

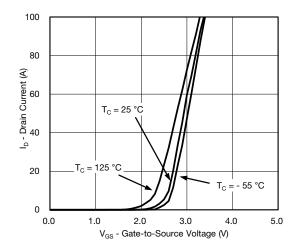


Output Characteristics

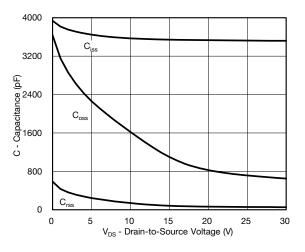




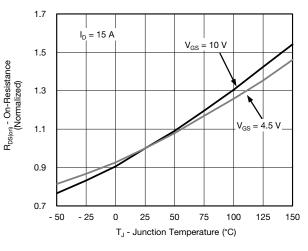




Transfer Characteristics







On-Resistance vs. Junction Temperature

S13-2179-Rev. A, 14-Oct-13

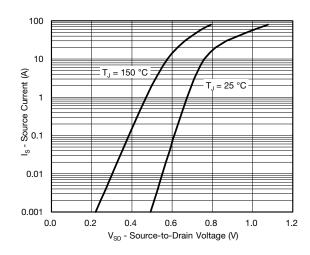
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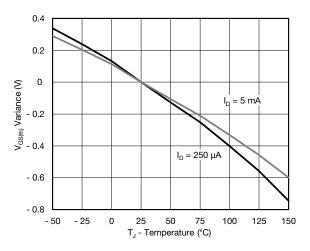


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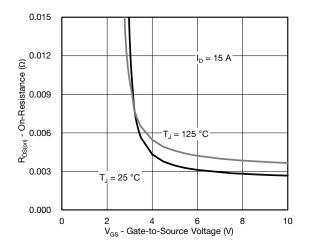
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



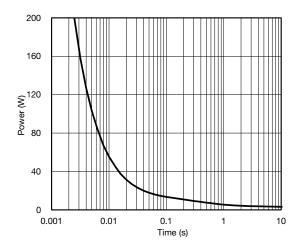
Source-Drain Diode Forward Voltage



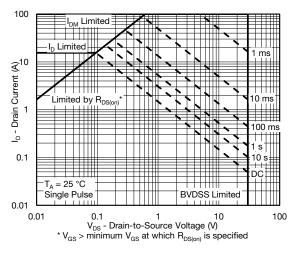
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

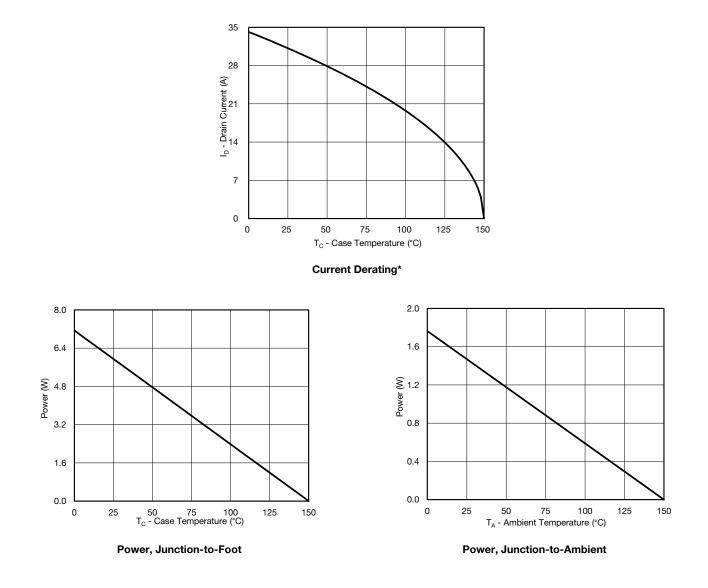
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



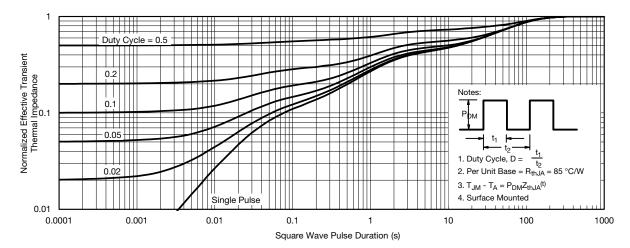
* The power dissipation P_D is based on T_{J(max.)} = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

Document Number: 62915

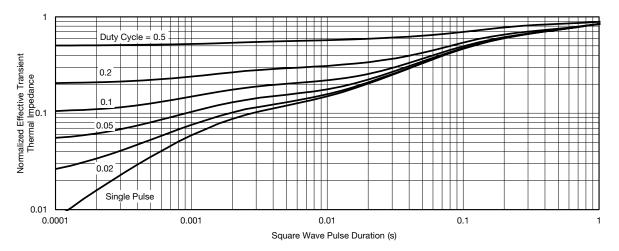


Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62915.



Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INC	HES	
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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